



# Teledyne Chip Scale Atomic Clock

The **Teledyne Chip Scale Atomic Clock (TCSAC)** is ideal for applications where a clock with high accuracy, high stability, and low power consumption is needed. The TCSAC provides these characteristics at an affordable price. Teledyne e2v has a long history of providing technology-based components and systems for use in complex applications.

The TCSAC is designed with a configurable output frequency to meet your particular application requirements. The unit will also accept an external 1 PPS signal to discipline its frequency and the phase of its 1 PPS output.

An RS-232 serial interface is available to monitor and control the unit. The interface also allows the TCSAC internal time of day to be set and interpreted.

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## KEY FEATURES (Preliminary)

- » Configurable Output Frequency
- » RS-232 Interface for Monitoring and Control
- » Short Term Stability (Allan Deviation) of  $3E-10$  @ TAU = 1 sec
- » RF Output Phase Noise (SSB) < -58 dBc/Hz @ 1 Hz
- » Aging <  $3E-10$ /month
- » Volume < 23 cc, 1.6" x 1.39" x 0.628"
- » Power Requirement < 180 mW

## APPLICATIONS

- » Banking/Financial Markets
  - » C4I, Tactical Communications/ECM and Soldier Systems
  - » Critical National Infrastructure (CNI) Protection
  - » Energy and Transport Infrastructure
  - » Fixed and Mobile Communications Networks (including 5G)
  - » GPS Challenged Environments and Autonomous Systems
  - » Sensor Networks
  - » Undersea Seismic Sensing and Scientific Applications
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Frequency	10 MHz, 16.384 MHz
Format	LVCMOS
Amplitude	0 V to 3.3 V
Load impedance	1 M $\Omega$
Number of outputs	1

Rise time	< 5 ns
Pulse width	1-200 $\mu$ s (programmable)
Logic low max (Vol)	< 0.5 V
Logic high min (Voh)	> 2.5 V
Load impedance	1 M $\Omega$
Number of outputs	1

Format	Rising edge
Logic low max (Vol)	< 0.5 V
Logic high min (Voh)	≥ 2.4 V and < 3.3 V
Input impedance	100 kΩ
Number of inputs	1

Protocol	RS-232
Format	LVC MOS, 0 V to 3.3 V
TX/RX impedance	100 k $\Omega$
Baud rate	38,400

Format	LVC MOS, 0 V to 3.3 V
Load impedance	100 kΩ
Logic	0 = Normal operation; 1 = Alarm

Input voltage (Vcc)	3.3 VDC; Range from 3.2 to 3.6 VDC
Operating	< 180 mW
Warm-up	< 205 mW

0.628" x 1.6" x 1.39"

42.6 gTBD

Operating temperature	-10°C to +60°C
Temperature coefficient	< 5 x 10 <sup>-10</sup>

PIN NO. I.D.			
1	Tune	7	Vcc
2	N/A	8	GND
3	N/A	9	1 PPS IN
4	BITE	10	1 PPS OUT
5	Tx	11	N/A
6	Rx	12	RF OUT

Frequency change over allowable input voltage range	$\pm 4 \times 10^{-10}$
Magnetic sensitivity ( $\leq 2.0$ Gauss)	$\pm 9 \times 10^{-11}$ /Gauss
Radiated emissions	Compliant to FCC part 15, Class B, when mounted properly onto host PCB
Vibration	Maintains lock under MIL-STD-810G, method 514.6, annex E, 7.7 grms
Humidity	0 to 95% RH per MIL-STD-810G, method 507.5 procedure II

Storage temperature	-55°C to +85°C
Shock (1 ms half-sine)	750 g

Tau = 1 sec	$3 \times 10^{-10}$
Tau = 10 sec	$1 \times 10^{-10}$
Tau = 100 sec	$3 \times 10^{-11}$
Tau = 1000 sec	$1 \times 10^{-11}$ (typical)

1 Hz	< -58 dBc/Hz
10 Hz	< -85 dBc/Hz
100 Hz	< -113 dBc/Hz
1000 Hz	< -130 dBc/Hz
10,000 Hz	< -140 dBc/Hz
100,000 Hz	< -142 dBc/Hz

Max offset at shipment	$\pm 5 \times 10^{-11}$
Max retrace (48 hrs. off)	$\pm 3 \times 10^{-10}$ (TBD)
Aging, monthly	$< 3 \times 10^{-10}$
Aging, yearly	$< 2 \times 10^{-9}$
1 PPS sync	+ 100 ns

Range	$\pm 4 \times 10^{-8}$
Resolution	$1.3 \times 10^{-12}$ (10 MHz); $1.5 \times 10^{-12}$ (16.384 MHz)

Range	$\pm 2.5 \times 10^{-9}$
Resolution	$1.3 \times 10^{-12}$ (10 MHz); $1.5 \times 10^{-12}$ (16.384 MHz)
Input	0-2.5V into 100 k $\Omega$

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